

# Nitrogen-Doped CuO@CuS Core-Shell Structure for Highly Efficient catalytic OER Application

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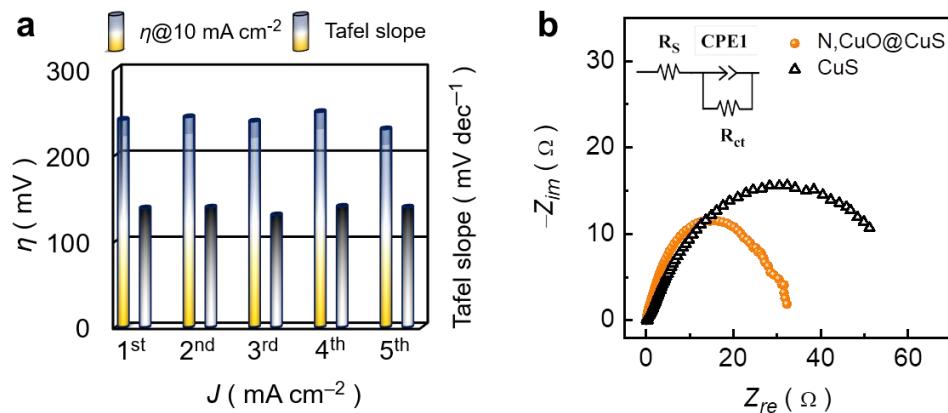
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## Supporting Figures



**Figure S1.** (a) Reliability of the OER activity for the N,CuO@CuS core-shell structure catalyst. (b) Nyquist impedance plots for CuS and N,CuO@CuS catalyst.

**Citation:** To be added by editorial staff during production.

Academic Editor: Firstname Lastname

Received: date

Revised: date

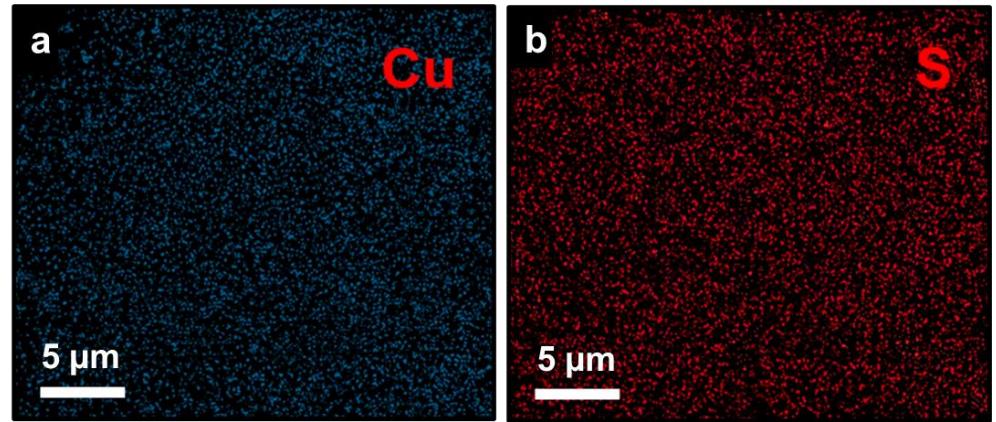
Accepted: date

Published: date

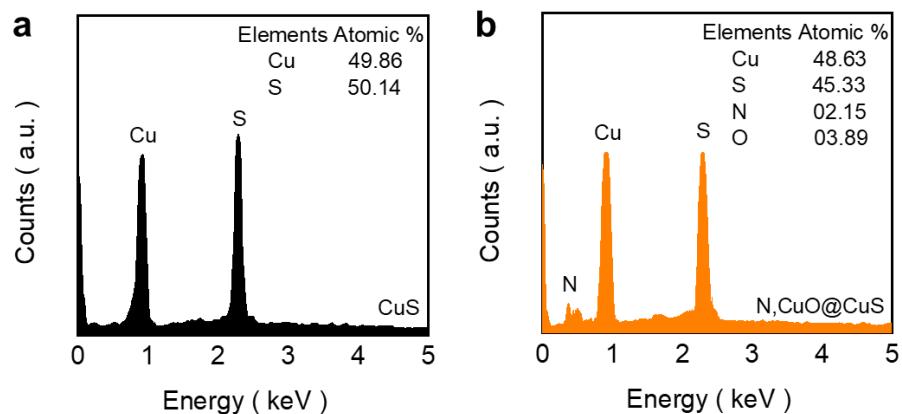


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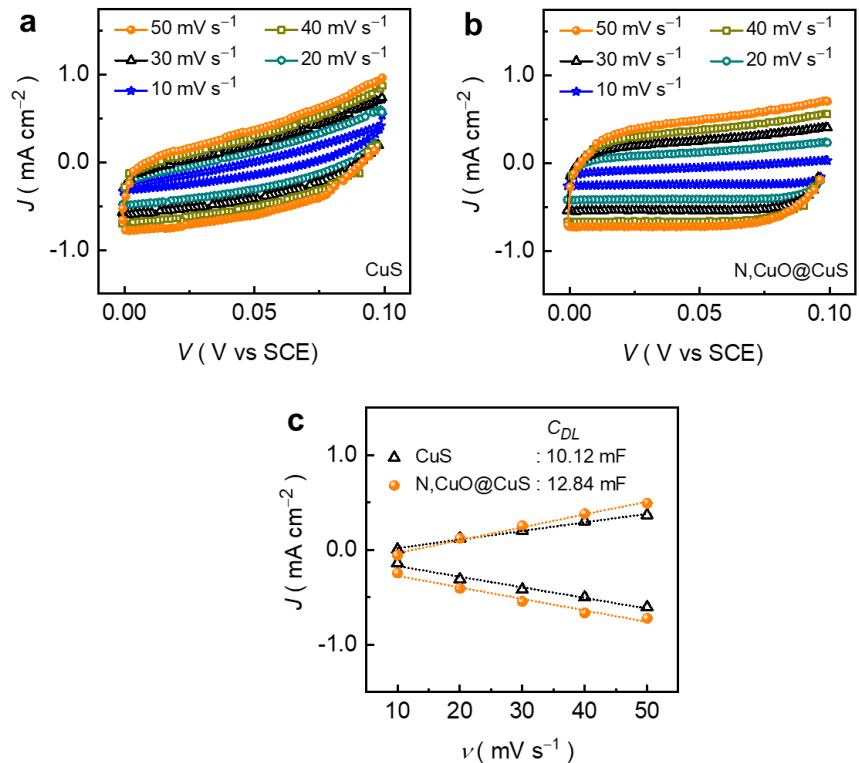
Nyquist impedance curves (EIS plots) were recorded to help understand the fundamental electron transfer kinetics of the CuS and N,CuO@CuS core-shell structure catalysts. Figure S1b shows the Nyquist impedance curves for both catalysts along with the tank circuit that was used to fit the semicircle curves (i.e., charge transfer resistance;  $R_{ct}$ ). The point at which the semicircles meet the X-axis illustrates the internal resistance of the electrodes (i.e.,  $R_s$ ). This resistance encompasses both the substrate's intrinsic resistance and the electrolyte resistance within the electrochemical system. The N,CuO@CuS possesses a smaller  $R_{ct}$  curve compared to pure CuS catalyst, indicating that the conductivity of the catalyst material has increased after nitrogen treatment.



**Figure S2.** (a) Cu and (b) S constituents EDS image mapping for the pure CuS electrode film.



**Figure S3.** EDS spectra for the (a) CuS and (b) N,CuO@CuS electrode films.



**Figure S4.** Non-Faradaic CV curves for (a) CuS and (b) N,CuO@CuS catalyst measured at various scan rates. (c) “ $J$  versus  $v$ ” plots obtained at 0.05 V from non-Faradaic CV curves for the estimation of double-layer capacitance and ECSA.